

## PATENT ASSIGNMENT COVER SHEET

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT

**CONVEYING PARTY DATA**

Name	Execution Date
CHIH-KAI CHANG	08/23/2018
BIN ZENG	08/23/2018
YAO-CHING HUANG	08/23/2018

**RECEIVING PARTY DATA**

<b>Name:</b>	U.D.ELECTRONIC CORP.
<b>Street Address:</b>	NO.13, LN.68, NEIXI RD.
<b>Internal Address:</b>	LUZHU DIST.
<b>City:</b>	TAOYUAN CITY
<b>State/Country:</b>	TAIWAN
<b>Postal Code:</b>	33852
<b>Name:</b>	U.D.(DONGGUAN) ELECTRONIC TECHNOLOGY CORP.
<b>Street Address:</b>	NO.1, XIN YUAN RD.
<b>Internal Address:</b>	LUDONG VILLAGE, HUMEN TOWN
<b>City:</b>	DONGGUAN CITY, GUANGDONG PROVINCE
<b>State/Country:</b>	CHINA
<b>Name:</b>	U.D.(ZHONG JIANG) ELECTRONIC CORP.
<b>Street Address:</b>	ZHONG JIANG INDUSTRIAL PARK, ZHONGJIANG COUNTY,
<b>City:</b>	DEYANG CITY, SICHUAN PROVINCE
<b>State/Country:</b>	CHINA

**PROPERTY NUMBERS Total: 1**

Property Type	Number
<b>Application Number:</b>	16120397

**CORRESPONDENCE DATA****Fax Number:**

*Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.*

**Phone:** 3474143524  
**Email:** daphnesung@earthlink.net  
**Correspondent Name:** YEN JUNG SUNG  
**Address Line 1:** 30-47 37 ST.

**PATENT**

<b>Address Line 4:</b>	ASTORIA, NEW YORK 11103
<b>ATTORNEY DOCKET NUMBER:</b>	ASIA-255-US5426
<b>NAME OF SUBMITTER:</b>	YEN JUNG SUNG
<b>SIGNATURE:</b>	/YEN JUNG SUNG/
<b>DATE SIGNED:</b>	09/03/2018
<b>Total Attachments: 2</b> source=Asia-255-US5426-ass#page1.tif source=Asia-255-US5426-ass#page2.tif	

## ASSIGNMENT OF INVENTION

In consideration of the payment by ASSIGNEE to ASSIGNOR(S) of the sum of One Dollar (\$1.00) and for other good and valuable consideration, the receipt of which is hereby acknowledged,

ASSIGNOR(S):

Name	Address
Chih-Kai CHANG	No.13, Ln.68, Neixi Rd., Luzhu Dist., Taoyuan City(33852), Taiwan
Bin ZENG	No.13, Ln.68, Neixi Rd., Luzhu Dist., Taoyuan City(33852), Taiwan
Yao-Ching HUANG	No.13, Ln.68, Neixi Rd., Luzhu Dist., Taoyuan City(33852), Taiwan

hereby sells, assigns and transfers to

ASSIGNEE:

Name	Address
1. U.D.ELECTRONIC CORP.	No.13, Ln.68, Neixi Rd., Luzhu Dist., Taoyuan City(33852), Taiwan
2. U.D.(DONGGUAN) ELECTRONIC TECHNOLOGY CORP.	No.1, Xin Yuan Rd., Ludong Village, humen Town, Dongguan City, Guangdong Province, China
3. U.D.(ZHONG JIANG) ELECTRONIC CORP.	Zhong Jiang Industrial Park, Zhongjiang County, Deyang City, Sichuan Province, China

and the successors, assigns and legal representatives of the ASSIGNEE, the entire right, title and interest for the United States and its territorial possessions, and in all foreign countries, including all rights to claim priority, in and to the invention entitled:

### CABLE CONNECTOR WITH FILTER FUNCTION

invented by Chih-Kai CHANG, Bin ZENG, and Yao-Ching HUANG and which is found in

- the U.S. patent application executed on even date herewith;
- the U.S. patent application executed on \_\_\_\_\_ ;
- the U.S. patent application no. \_\_\_\_\_ filed on \_\_\_\_\_ ;
- the U.S. patent no. \_\_\_\_\_ issued on \_\_\_\_\_ ;

and, in and to all Letters Patent, both foreign and domestic, to be obtained for said invention by the above application or any continuation, division, renewal, continuation-in-part or substitute thereof, and as to Letters Patent and any reissue or re-examination thereof, and to any legal equivalent thereof in a foreign country, including, the right to apply for patents and inventor certificates in respect thereof, the right to claim priority, and all patents, patents of addition, utility models, patents of importation, revalidation patents and inventor certificates which may be granted throughout the world in respect of the invention.

ASSIGNOR(S) hereby authorizes ASSIGNEE or its legal representative to insert in this instrument the filing date and serial number of said application or any other information that may be necessary or desirable in order to comply with the rules of the U.S. Patent and Trademark Office for the recordation of this document.

ASSIGNOR(S) hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment.

ASSIGNOR(S) further covenants and agrees that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to ASSIGNOR(S), and that ASSIGNOR(S) will, at ASSIGNEE's expense, testify as to the same in any interference, litigation or proceeding related thereto

and will promptly execute and deliver to ASSIGNEE, its assigns or its legal representatives, without further or additional consideration, any and all papers, instruments or affidavits required, render all necessary assistance, and do such additional acts as ASSIGNEE may deem necessary or desirable, to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the purposes thereof.

ASSIGNOR(S) hereby authorize and request the Commissioner of Patents and Trademarks to issue any and all United States Letters Patent referred to above to ASSIGNEE of the entire right, title and interest in and to the same, for ASSIGNEE's sole use and benefit, and for the use and benefit of ASSIGNEE's legal representatives and successors, to the full end of the term for which such Letters Patent may be granted, as fully and entirely as the same would have been held by ASSIGNOR(S) had this assignment and sale not been made.

The parties agree that the foregoing covenants and obligations shall bind and inure to the benefit of the heirs, assigns and legal representatives of both parties.

Name: Chih-Kai CHANG

Chih-Kai CHANG  
Signature

Date: August 23, 2018

Name: Bin ZENG

Bin ZENG  
Signature

Date: August 23, 2018

Name: Yao-Ching HUANG

Yao-Ching HUANG  
Signature

Date: August 23, 2018